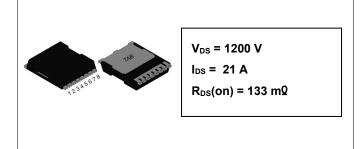




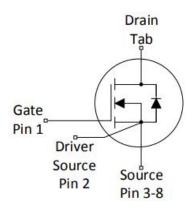
S2M0120120T 1200V SIC POWER MOSFET



Description

S2M0120120T is single SiC Power MOSFET packaged in TOLL case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0120120T is ideal for energy sensitive, high frequency applications in challenging environments.

Circuit Diagram



Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 133 m^Q .
- Fast switching speed and low switching losses.
- · Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	V _{GS} = 0V, I _{DS} = 100uA, T _C = 25°C	1200	V
Gate Source Voltage	V _{GSS}	T _C = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	V _{GSOP}	T _C = 25°C, Recommended Operational Values	-5 to +20	V
	I _D	V _{GS} = 20V, T _C = 25°C	21	А
Continuous Drain Current	I _D	V _{GS} = 20V, T _C = 100°C	15	А
Pulsed Drain Current	I _{D,pulse}	Pulse width t _P limited by T _{jmax}	66	Α
Power Dissipation	P _D	T _C =25°C, T _J = 175 °C	156	W

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Electrical Characteristics(T=25℃ unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 100 uA	1200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 3.3 \text{ mA}$	2.0	2.9	4	V	
		V _{DS} = V _{GS} , I _D = 3.3 mA, T _J = 175 °C		1.9		V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200 V, V _{GS} = 0 V		1	100	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20 V, V _{DS} = 0 V			250	nA	
Drain Source On-State		V _{GS} = 20 V, I _D = 13.3 A		133	150	mΩ	
Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 13.3 A, T _J = 175 °C		212		mΩ	
T		V _{DS} = 20 V, I _D = 13.3 A		5		S	
Transconductance	gfs	V _{DS} = 20 V, I _D = 13.3 A, T _J = 175 °C		2		S	
Input Capacitance	C _{ISS}	V _{GS} = 0 V,		652			
Output Capacitance	Coss	V _{DS} = 1000 V		47.6		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25 mV f = 100 kHz		3.47			
Coss Stored Energy	Eoss	1 100 M 12		28		uJ	
Turn-On Switching Energy	Eon	V _{DS} = 800 V, V _{GS} = -5/+20 V		62.3		_	
Turn-Off Switching Energy	E _{OFF}	ID =13.3 A, RG(ext)=2.5 Ω		62.7		uJ	
Turn-On Delay Time	$t_{\text{d(on)}}$			3.5			
Rise Time	t _r	V = 000 V V = 5/00 V		6.7			
Turn-Off Delay Time	t _{d(off)}	$V_{DS} = 800 \text{ V}, V_{GS} = -5/20 \text{ V}$ $I_{D} = 13.3 \text{ A}, R_{G(ext)} = 2.5 \Omega, R_{L} = 80 \Omega$		8.3		ns	
Fall Time	t _f	15 15 15 15 15 15 15 15 15 15 15 15 15 1		10.6			
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV, D-S short		6.4		Ω	
Gate to Source Charge	Q _{gs}	V _{DS} = 800 V, V _{GS} = -5/20 V		12.8			
Gate to Drain Charge	Q_{gd}	I _D = 13.3 A		6.0		nC	
Total Gate Charge	Qg			29.6			

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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V_{SD}	V _{GS} = -5 V, I _{SD} = 6.7 A	3.7		V
	V _{SD}	V _{GS} = -5 V, I _{SD} = 6.7 A, T _J = 175 °C	3.3		V
Continuous Diode Forward Current	Is	V _{GS} = -5 V, T _C = 25 °C	20		Α
Reverse Recovery Time	t _{rr}	V _{GS} = -5 V, I _{SD} = 13.3 A, T _J = 25 °C	7.3		ns
Reverse Recovery Charge	Qrr	V _R = 800 V	0.05		uC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 3030 A/μs	11.9		Α

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R ₀ JC	DC operation	0.96	°C/W

Ordering Information:

Device	Package	Shipping
S2M0120120T	TOLL	1800pcs/Reel

Marking Diagram



Where XXXXX is YYWWL

 $\begin{array}{ll} S2M & = Device Type \\ 0120 & = R_{DS}(on) \end{array}$

120 = Reverse Voltage (1200V)

T = Package SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

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Ratings and Characteristics Curves

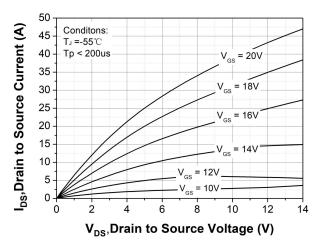


Figure 1. Output Characteristics T_J = -55 °C

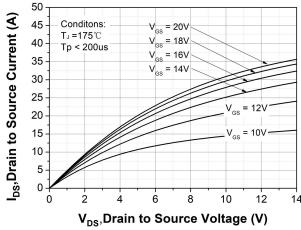


Figure 3. Output Characteristics T_J = 175°C

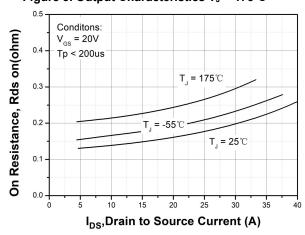


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

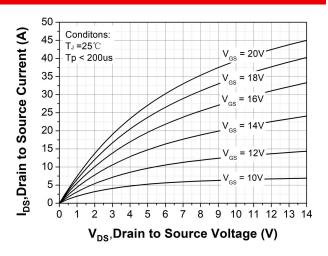


Figure 2. Output Characteristics T_J = 25 °C

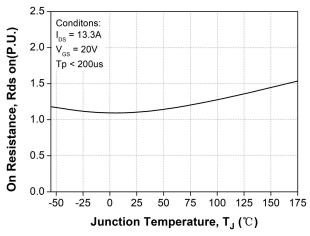


Figure 4. Normalized On-Resistance vs. Temperature

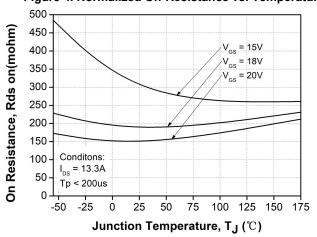


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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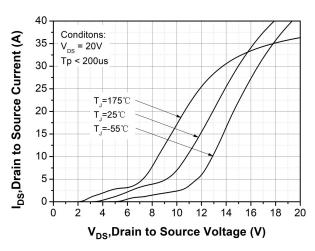


Figure 7. Transfer Characteristic for Various Junction Temperatures

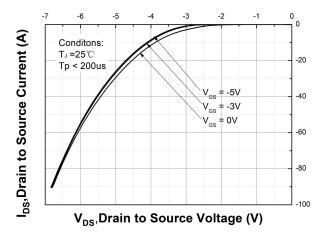


Figure 9. Body Diode Characteristic at T_J = 25 °C

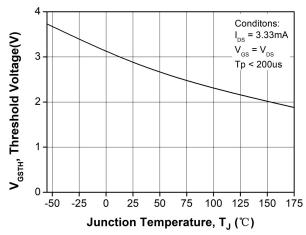


Figure 11. Threshold Voltage vs. Temperature

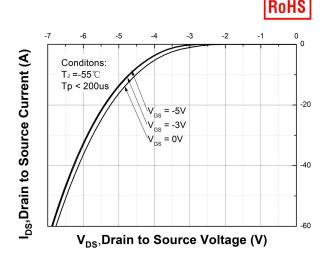


Figure 8. Body Diode Characteristic at T_J = -55 °C

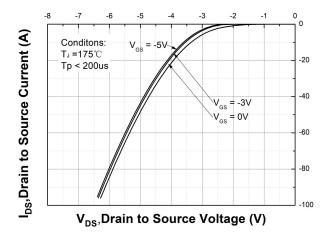


Figure 10. Body Diode Characteristic at T_J = 175 °C

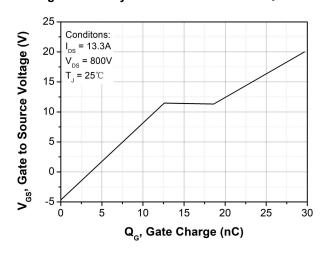


Figure 12. Gate Charge Characteristic

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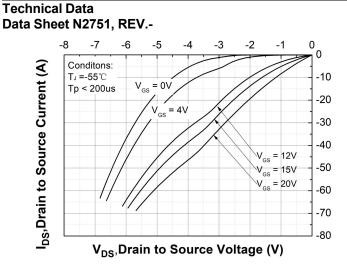


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

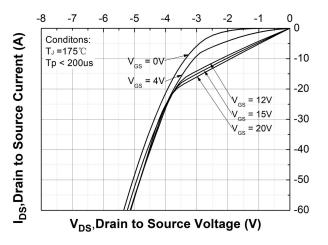


Figure 15. 3rd Quadrant Characteristic at T_J = 175°C

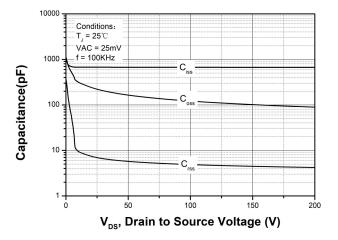


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

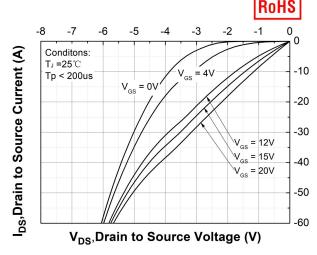


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

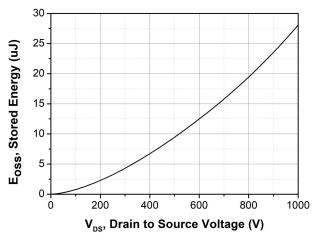


Figure 16. Output Capacitor Stored Energy

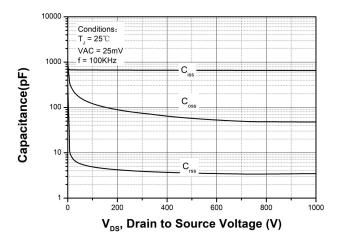


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

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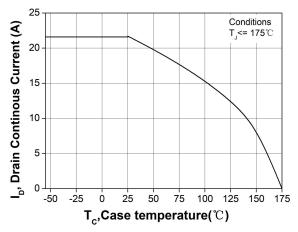


Figure 19. Continuous Drain Current Derating vs. Case Temperature

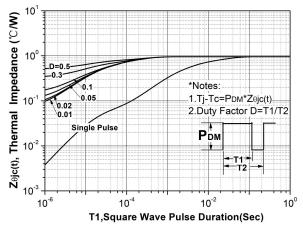


Figure 21. Transient Thermal Impedance (Junction - Case)

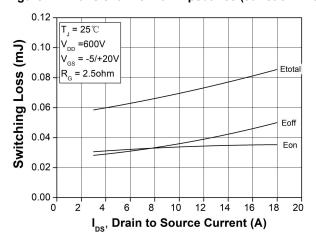


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)



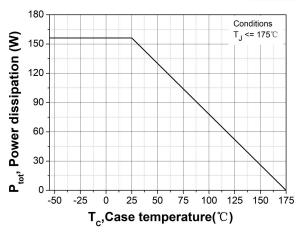


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

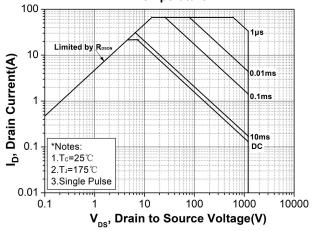


Figure 22. Safe Operating Area

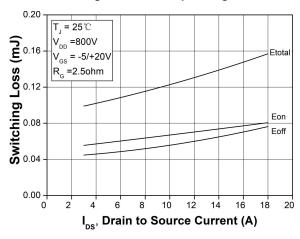


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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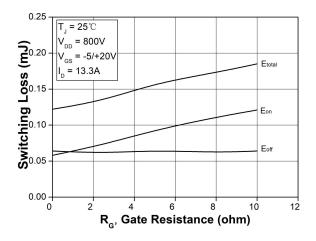


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

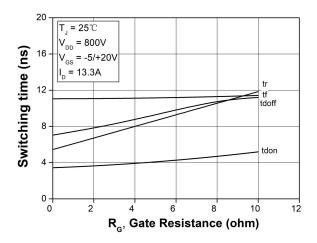


Figure 27. Switching Times vs. R_{G(ext)}

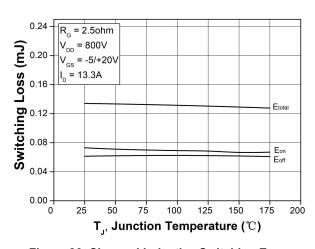


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

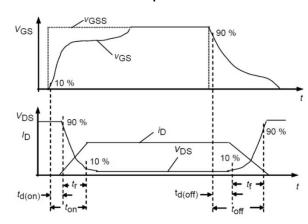
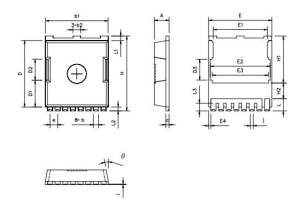


Figure 28. Switching Times Definition





Mechanical Dimensions TOLL



Min. NOM. Max A 2.20 2.30 2.40 b 0.70 0.80 0.90 b1 9.70 9.80 9.90 b2 1.20 REF. c 0.40 0.50 0.60 D 10.28 10.38 10.48 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. i 0.10 j 0.45 REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70	SYMBOL	Dimensions In Millimeters				
b 0.70 0.80 0.90 b1 9.70 9.80 9.90 b2 1.20 REF. 0.60 0.60 c 0.40 0.50 0.60 D 10.28 10.38 10.48 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. 1 0.10 - - j 0.10 - - - - j 0.45 REF. - - - -	TIMBOL	Min.	NOM.	Max.		
b1 9.70 9.80 9.90 b2 1.20 REF. 0.60 0.60 c 0.40 0.50 0.60 D 10.28 10.38 10.46 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. 8.60 8.60 E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. 1 0.10 - j 0.45 REF. - - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 <	A	2.20	2.30	2.40		
b2 1.20 REF. c 0.40 0.50 0.60 D 10.28 10.38 10.48 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. 8.60 8.50 0.45 E4 0.25 0.35 0.45 0.45	b	0.70	0.80	0.90		
c 0.40 0.50 0.60 D 10.28 10.38 10.48 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 12.0 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. 1 0.10 - j 0.45 REF. - - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	b1	9.70	9.80	9.90		
D 10.28 10.38 10.46 D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. 1 0.10 - - - j 0.45 REF. 1 -	b2		1.20 REF.			
D1 4.08 4.18 4.28 D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. - - j 0.45 REF. - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	c	0.40	0.50	0.60		
D2 3.20 3.30 3.40 D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. - - j 0.45 REF. - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	D	10.28	10.38	10.48		
D3 3.16 3.26 3.36 E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. 1 0.10 - - j 0.45REF. - - - - - L 1.60 1.90 2.10 -	D1	4.08	4.18	4.28		
E 9.80 9.90 10.00 E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. i 0.10 j 0.45REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	D2	3.20	3.30	3.40		
E1 8.40 8.50 8.60 E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 E 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. i 0.10 j 0.45REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	D3	3.16	3.26	3.36		
E2 9.30 9.40 9.50 E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. - - i 0.10 - - j 0.45REF. - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	E	9.80	9.90	10.00		
E3 8.8 REF. E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.76 H1 7.23 7.33 7.43 H2 2.45 REF. i 0.10	E1	8.40	8.50	8.60		
E4 0.25 0.35 0.45 e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. - - j 0.45 REF. - - j 0.45 REF. - - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	E2	9.30	9.40	9.50		
e 1.20 BASIC H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 245 REF. i 0.10 j 0.45 REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	E3	8.8 REF.				
H 11.58 11.68 11.78 H1 7.23 7.33 7.43 H2 2.45 REF. . . i 0.10 - - j 0.45REF. . . L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	E4	0.25	0.35	0.45		
H1 7.23 7.33 7.43 H2 2.45 REF. i 0.10 j 0.45 REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	e	1.20 BASIC				
H2 2.45 REF. i 0.10 - - j 0.45REF. - - L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	н	11.58	11.68	11.78		
i 0.10	H1	7.23	7.33	7.43		
j 0.45REF. L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	H2		The second secon			
L 1.60 1.90 2.10 L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	1	0.10		199		
L1 0.60 0.70 0.80 L2 0.50 0.60 0.70 L3 1.06 1.20 1.30	j	0.45REF.				
L2 0.50 0.60 0.70 L3 1.05 1.20 1.30	L	1.60	1.90	2.10		
L3 1.05 1.20 1.30	L1	0.60	0.70	0.80		
	L2	0.50	0.60	0.70		
e 10" REF.	L3	1.05	1.20	1.30		
	0	10" REF.				

S2M0120120T



Technical Data Data Sheet N2751, REV.-



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- 1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the SMC Diode Solutions sales department for the latest version of the datasheet(s).
- 2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.
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